

## SMB Surface Mount Schottky Barrier Rectifier

### Features

- For surface mounted applications
- High forward surge current capability
- Low power losses, high efficiency
- Built-in strain relief, ideal for automated placement
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260°C

**Reverse Voltage**

20-200 V

**Forward Current**

5 Ampere

### Applications

For use in low voltage high frequency inverters, free wheeling, and polarity protection applications.

### Mechanical Data

- Case: DO-214AA(SMB)  
Molding compound meets UL 94V-0 flammability rating, RoHS-compliant, halogen-free
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Cathode line denotes the cathode end

### Function Diagram



### Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS52B	SS53B	SS54B	SS55B	SS56B	SS58B	SS510B	SS515B	SS520B
Device marking code			SS52B	SS53B	SS54B	SS55B	SS56B	SS58B	SS510B	SS515B	SS520B
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	V	20	30	40	50	60	80	100	150	200
Maximum RMS Voltage	V <sub>RMS</sub>	V	14	21	28	35	42	56	70	105	140
Maximum DC blocking Voltage	V <sub>DC</sub>	V	20	30	40	50	60	80	100	150	200
Maximum Average Forward Rectified Current @60Hz sinewave, Resistance load,TL (Fig.1)	I <sub>F(AV)</sub>	A						5.0			
Non-repetitive Peak Forward Surge Current @ t=8.3ms Half-sine wave	I <sub>FSM</sub>	A						120			
Storage temperature	T <sub>stg</sub>	°C						-55 ~ +150			
Junction temperature	T <sub>j</sub>	°C			-55 ~ +125				-55 ~ +150		
Typical Thermal Resistance	R <sub>θJ-A</sub>	°C /W						60			
	R <sub>θJ-L</sub>	°C /W						22			

# SS52B THRU SS520B

SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

## ● Electrical Characteristics (Ta=25°C Unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	UNIT	SS52B	SS53B	SS54B	SS55B	SS56B	SS58B	SS510B	SS515B	SS520B
Maximum instantaneous forward voltage	$I_F=5.0A$	$V_F$	V	0.55	0.70	0.85	0.95					
Maximum DC reverse current at rated DC blocking voltage	$V_R=V_{DC}, T_A=25^\circ C$	$I_{R1}$	mA		0.2					0.05		
	$V_R=V_{DC}, T_A=100^\circ C$	$I_{R2}$			10					5		
Typical junction capacitance	4.0V DC,1MHz	$C_J$	pF						300			

## ● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)

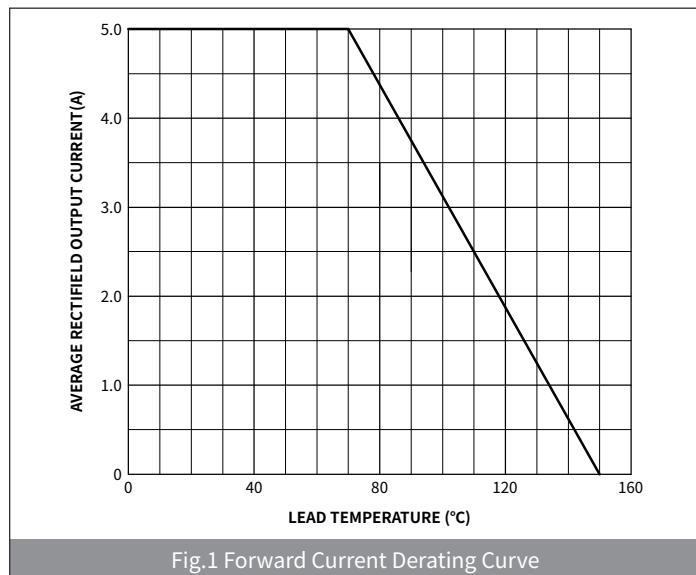


Fig.1 Forward Current Derating Curve

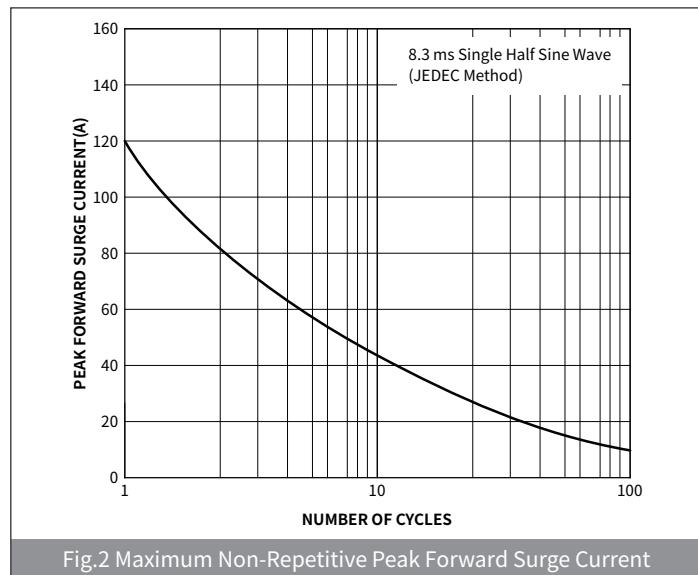


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

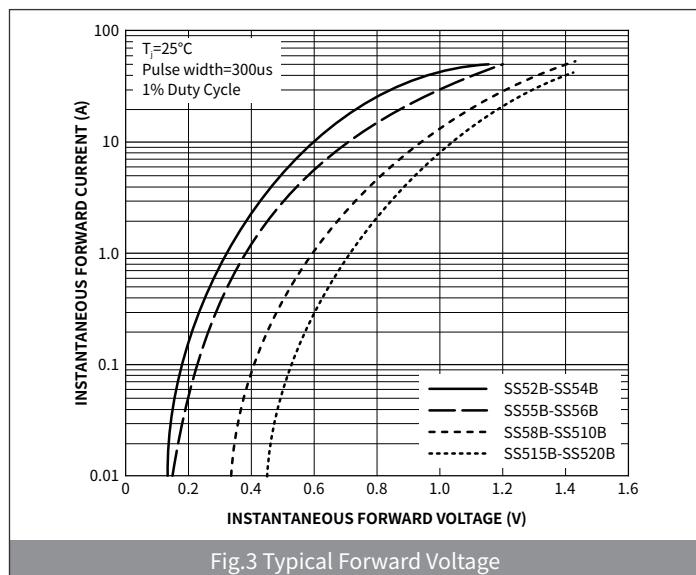


Fig.3 Typical Forward Voltage

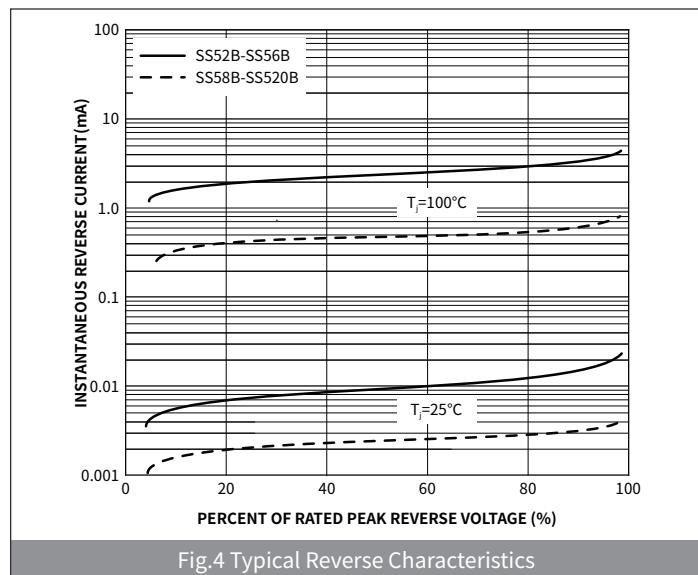
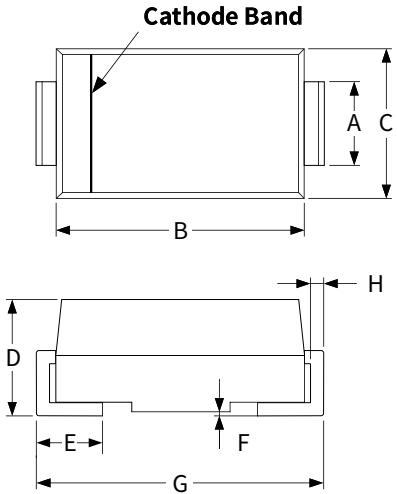


Fig.4 Typical Reverse Characteristics

### ● Ordering Information

PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
SMB	R3	0.098	3000	6000	48000	13"

### ● Package Outline Dimensions (SMB/DO-214AA)

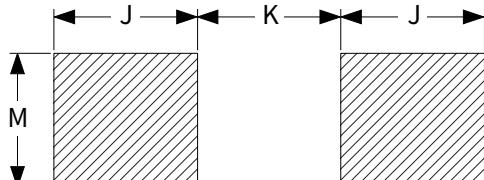


The diagram illustrates the Cathode Band package outline with the following dimensions:

- A: Height from the bottom edge to the top of the cathode band.
- B: Width of the cathode band.
- C: Total height of the package.
- D: Total width of the package.
- E: Width of the lead-free zone on each side of the cathode band.
- F: Lead thickness.
- G: Total width of the leads.
- H: Lead spacing.

Symbol	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.85	2.21	0.073	0.087
B	4.25	4.85	0.167	0.191
C	3.30	3.94	0.130	0.155
D	2.15	2.65	0.085	0.104
E	0.75	1.52	0.030	0.060
F	-	0.203	-	0.008
G	5.08	5.59	0.200	0.220
H	0.15	0.31	0.006	0.012

### ● Suggested Pad Layout



The diagram illustrates the suggested pad layout with the following dimensions:

- J: Width of the central pad.
- K: Width of the gap between the central pad and the outer pad.
- M: Total height of the pads.

Symbol	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
M	2.26	-	0.089	-
J	2.10	-	0.085	-
K	-	2.74	-	0.107

Rev:1.0

Zhuhai Hongjiacheng Technology co., Ltd

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